Lattice Semiconductor Corporation - LFE2-12E-7Q208C Datasheet

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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

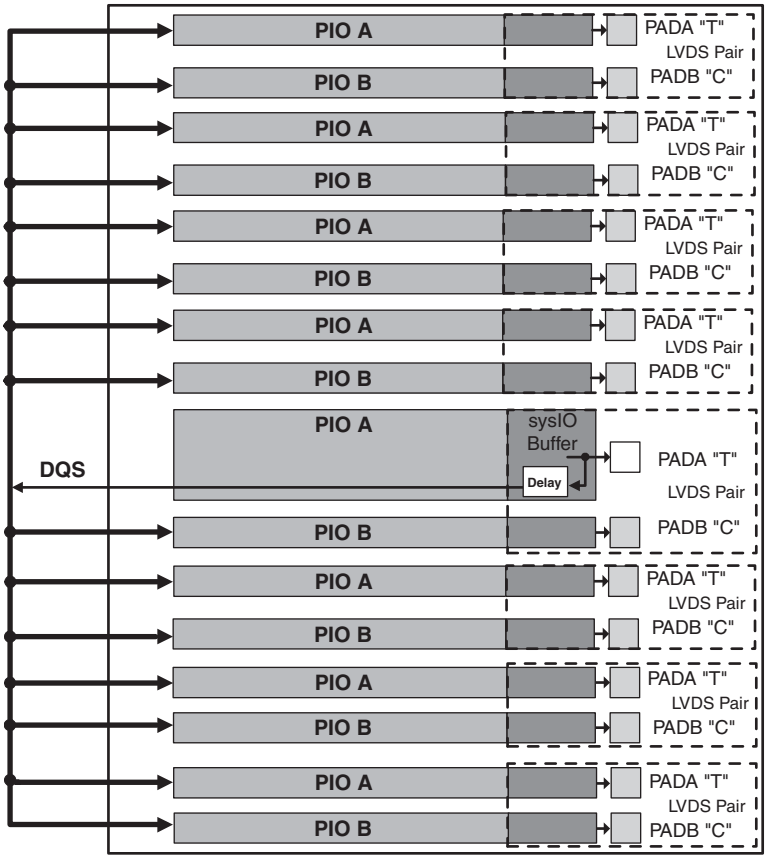
Details	
Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	131
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12e-7q208c

Top Edge

The PICs on the top edge are different from PIOs on the left, right and bottom edges. PIOs on this edge do not have DDR registers or DQS signals.

The exact DQS pins are shown in a dual function in the Logic Signal Connections table in this data sheet. Additional detail is provided in the Signal Descriptions table. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. Interfaces on the left and right edges are designed for DDR memories that support 16 bits of data, whereas interfaces on the bottom are designed for memories that support 18 bits of data.

Figure 2-33. DQS Input Routing for the Left and Right Edges of the Device



DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}[1, 2]	Input or I/O Low Leakage	$0 \le V_{IN} \le (V_{CCIO} - 0.2V)$	—	—	10	µA
I_{IH}[1, 3]	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) < V_{IN} \le 3.6V$	—	—	150	µA
I_{PU}	I/O Active Pull-up Current	$0 \le V_{IN} \le 0.7\ V_{CCIO}$	-30	—	-210	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) $\le V_{IN} \le V_{IH}$ (MAX)	30	—	210	µA
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL}$ (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7\ V_{CCIO}$	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \le V_{IN} \le V_{CCIO}$	—	—	210	µA
I_{BHHO}	Bus Hold High Overdrive Current	$0 \le V_{IN} \le V_{CCIO}$	—	—	-210	µA
V_{BHT}	Bus Hold Trip Points	$0 \le V_{IN} \le V_{IH}$ (MAX)	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C1[4]	I/O Capacitance	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	5	8	pf
C2[4]	Dedicated Input Capacitance	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	5	6	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. When used as V_{REF}, maximum leakage = 25uA
3. Applicable to general purpose I/Os in top and bottom banks.
4. T_A 25°C, f = 1.0MHz.

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter	Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input Voltage		0	—	2.4	V
V_{CM}	Input Common Mode Voltage	Half the Sum of the Two Inputs	0.05	—	2.35	V
V_{THD}	Differential Input Threshold	Difference Between the Two Inputs	+/-100	—	—	mV
I_{IN}	Input Current	Power On or Power Off	—	—	+/-10	µA
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	—	1.38	1.60	V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	R_T = 100 Ohm	0.9V	1.03	—	V
V_{OD}	Output Voltage Differential	(V_{OP} - V_{OM}), R_T = 100 Ohm	250	350	450	mV
ýV$_{OD}$	Change in V_{OD} Between High and Low		—	—	50	mV
V_{OS}	Output Voltage Offset	(V_{OP} + V_{OM})/2, R_T = 100 Ohm	1.125	1.20	1.375	V
ýV$_{OS}$	Change in V_{OS} Between H and L		—	—	50	mV
I_{SA}	Output Short Circuit Current	V_{OD} = 0V Driver Outputs Shorted to Ground	—	—	24	mA
I_{SAB}	Output Short Circuit Current	V_{OD} = 0V Driver Outputs Shorted to Each Other	—	—	12	mA

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DIBSPI}	Data Invalid Before Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps
XGMII I/O Pin Parameters (312 Mbps)[5]									
$t_{SUXGMII}$	Data Setup Before Read Clock	ECP2/M	480	—	480	—	480	—	ps
t_{HXGMII}	Data Hold After Read Clock	ECP2/M	480	—	480	—	480	—	ps
$t_{DVBCKXGMII}$	Data Valid Before Clock	ECP2/M	960	—	960	—	960	—	ps
$t_{DVACKXGMII}$	Data Valid After Clock	ECP2/M	960	—	960	—	960	—	ps
Primary									
f_{MAX_PRI}[7]	Frequency for Primary Clock Tree	ECP2/M	—	420	—	357	—	311	MHz
t_{W_PRI}	Clock Pulse Width for Primary Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t_{SKEW_PRI}	Primary Clock Skew Within a Bank	ECP2/M	—	300	—	360	—	420	ps
Edge Clock									
f_{MAX_EDGE}[7]	Frequency for Edge Clock	ECP2/M	—	420	—	357	—	311	MHz
t_{W_EDGE}	Clock Pulse Width for Edge Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t_{SKEW_EDGE}	Edge Clock Skew Within an Edge of the Device	ECP2/M	—	300	—	360	—	420	ps

1. General timing numbers based on LVCMOS 2.5, 12mA, 0pf load.
2. DDR timing numbers based on SSTL25 for BGA packages only.
3. DDR2 timing numbers based on SSTL18 for BGA packages only.
4. SPI4.2 and SFI4 timing numbers based on LVDS25 for BGA packages only.
5. XGMII timing numbers based on HSTL class I. A corresponding left/right dedicated clock buffer is used when using the SPI4.2 interface to the left or right edge of the device. For SPI4.2 mode, the software tool will help in selecting the appropriate clock buffer.
6. IP will be used to support DDR and DDR2 memory data rates down to 95MHz. This approach uses a free-running clock and PFU register to sample the data instead of the hardwired DDR memory interface.
7. Using the LVDS I/O standard.
8. ECP2-6 and ECP2-12 do not support SPI4.2
9. The AC numbers do not apply to PCLK6 and PCLK7.
10. Applies to CLKOP only.
11. Please refer to TN1159, LatticeECP2/M Pin Assignment Recommendations for best performance.

sysCLOCK SPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	33	—	420	MHz
		With external capacitor[5, 6]	2	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	33	—	420	MHz
		With external capacitor[5]	5	—	50	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.258	—	210	MHz
		With external capacitor[5]	0.039	—	25	MHz
f_{VCO}	PLL VCO Frequency		640	—	1280	MHz
f_{PFD}	Phase Detector Input Frequency	Without external capacitor	33	—	420	MHz
		With external capacitor[6]	2	—	50	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default Duty Cycle Selected[3]	45	50	55	%
t_{PH}[4]	Output Phase Accuracy		—	—	±0.05	UI
t_{OPJIT}[1]	Output Clock Period Jitter	$f_{OUT} \geq 100$ MHz	—	—	±125	ps
		$50 \leq f_{OUT} < 100$ MHz	—	—	0.025	UIPP
		$f_{OUT} < 50$ MHz	—	—	0.04	UIPP
t_{SK}	Input Clock to Output Clock Skew	Divider Ratio = Integer	—	—	±250	ps
t_W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t_{LOCK}[2]	PLL Lock-in Time	Without external capacitor	—	—	150	µs
		With external capacitor[5]	—	—	500	µs
t_{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t_{FBKDLY}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width (RSTK)		15	—	—	ns
	Reset Signal Pulse Width (RST)	Without external capacitor	500	—	—	ns
		With external capacitor[5]	20	—	—	µs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.
2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. Phase accuracy of CLKOS compared to CLKOP.
5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.
6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPIm mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPIm. When using the SPI or SPIm mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPIm
DOUT/CSON	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIm modes.
Dedicated SERDES Signals[1, 2, 3]		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
138	PR15A	3	PCLKT3_0	T (LVDS)*	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*
139	GND	-			GND	-		
140	VCC	-			VCC	-		
141	PR13B	2	PCLKC2_0/RDQ10	C	PR19B	2	PCLKC2_0/RDQ16	C
142	PR13A	2	PCLKT2_0/RDQ10	T	PR19A	2	PCLKT2_0/RDQ16	T
143	VCCIO2	2			VCCIO2	2		
144	PR12A	2	RDQ10		PR16A	2	RDQS16	
145	GND	-			GND	-		
146	VCC	-			VCC	-		
147	PR8B	2	RDQ10	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
148	VCCIO2	2			VCCIO2	2		
149	PR8A	2	RDQ10	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
150	PR6B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
151	VCCAUX	-			VCCAUX	-		
152	PR6A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
153	PR4B	2		C (LVDS)*	PR6B	2	RDQ8	C (LVDS)*
154	PR4A	2		T (LVDS)*	PR6A	2	RDQ8	T (LVDS)*
155	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
156	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
157	PT55B	1	VREF2_1	C	PT64B	1	VREF2_1	C
158	PT55A	1	VREF1_1	T	PT64A	1	VREF1_1	T
159	GND	-			GND	-		
160	PT54B	1		C	PT62B	1		C
161	PT54A	1		T	PT62A	1		T
162	VCCIO1	1			VCCIO1	1		
163	PT52B	1		C	PT60B	1		C
164	PT52A	1		T	PT60A	1		T
165	PT50B	1		C	PT58B	1		C
166	PT50A	1		T	PT58A	1		T
167	PT48B	1		C	PT56B	1		C
168	PT48A	1		T	PT56A	1		T
169	GND	-			GND	-		
170	VCCIO1	1			VCCIO1	1		
171	VCC	-			VCC	-		
172	PT40B	1		C	PT50B	1		C
173	PT40A	1		T	PT50A	1		T
174	VCCAUX	-			VCCAUX	-		
175	GND	-			GND	-		
176	PT36B	1		C	PT44B	1		C
177	PT36A	1		T	PT44A	1		T
178	PT34B	1		C	PT42B	1		C
179	PT34A	1		T	PT42A	1		T
180	PT30B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C
181	PT30A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T
182	XRES	1			XRES	1		
183	PT28B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F19	PR5A	2		T	PR7A	2	RDQ8	T
D20	PR4A	2		T (LVDS)*	PR6A	2	RDQ8	T (LVDS)*
F18	PR3B	2		C	PR5B	2	RDQ8	C
VCCIO	VCCIO2	2			VCCIO2	2		
C21	NC	-			PR4B	2	RDQ8	C (LVDS)*
F16	PR3A	2		T	PR5A	2	RDQ8	T
C22	NC	-			PR4A	2	RDQ8	T (LVDS)*
-	-	-			GNDIO	-		
D19	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
E19	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
B21	PT55B	1	VREF2_1	C	PT64B	1	VREF2_1	C
B22	PT55A	1	VREF1_1	T	PT64A	1	VREF1_1	T
GNDIO	GNDIO1	-			GNDIO1	-		
D18	PT53B	1		C	PT62B	1		C
C20	PT54B	1		C	PT63B	1		C
E18	PT53A	1		T	PT62A	1		T
C19	PT54A	1		T	PT63A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D17	PT51B	1		C	PT60B	1		C
B20	PT52B	1		C	PT61B	1		C
C18	PT51A	1		T	PT60A	1		T
A19	PT52A	1		T	PT61A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
A18	PT49B	1		C	PT58B	1		C
A21	PT50B	1		C	PT59B	1		C
B18	PT49A	1		T	PT58A	1		T
A20	PT50A	1		T	PT59A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D16	PT47B	1		C	PT56B	1		C
G16	PT48B	1		C	PT57B	1		C
E16	PT47A	1		T	PT56A	1		T
G15	PT48A	1		T	PT57A	1		T
C17	PT46B	1		C	PT55B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C16	PT46A	1		T	PT55A	1		T
A17	PT44B	1		C	PT53B	1		C
B17	PT45B	1		C	PT54B	1		C
A16	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B16	PT45A	1		T	PT54A	1		T
E15	PT42B	1		C	PT51B	1		C
C15	PT43B	1		C	PT52B	1		C
F15	PT42A	1		T	PT51A	1		T
D15	PT43A	1		T	PT52A	1		T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L2	NC	-			NC	-		
L1	NC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
M2	NC	-			NC	-		
M1	NC	-			NC	-		
N2	NC	-			NC	-		
GND	GNDIO7	-			GNDIO7	-		
M8	VCC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
GND	GNDIO7	-			GNDIO7	-		
N1	PL12A	7	LDQ16		PL18A	7	LDQ22	
L8	PL13A	7	LDQ16	T	PL19A	7	LDQ22	T
K8	PL13B	7	LDQ16	C	PL19B	7	LDQ22	C
VCCIO	VCCIO7	7			VCCIO7	7		
L6	PL14A	7	LDQ16	T (LVDS)*	PL20A	7	LDQ22	T (LVDS)*
K5	PL14B	7	LDQ16	C (LVDS)*	PL20B	7	LDQ22	C (LVDS)*
L7	PL15A	7	LDQ16	T	PL21A	7	LDQ22	T
L5	PL15B	7	LDQ16	C	PL21B	7	LDQ22	C
GND	GNDIO7	-			GNDIO7	-		
P1	PL16A	7	LDQS16	T (LVDS)*	PL22A	7	LDQS22	T (LVDS)*
P2	PL16B	7	LDQ16	C (LVDS)*	PL22B	7	LDQ22	C (LVDS)*
M6	PL17A	7	LDQ16	T	PL23A	7	LDQ22	T
VCCIO	VCCIO7	7			VCCIO7	7		
N8	PL17B	7	LDQ16	C	PL23B	7	LDQ22	C
R1	PL18A	7	LDQ16	T (LVDS)*	PL24A	7	LDQ22	T (LVDS)*
R2	PL18B	7	LDQ16	C (LVDS)*	PL24B	7	LDQ22	C (LVDS)*
M7	PL19A	7	PCLKT7_0/LDQ16	T	PL25A	7	PCLKT7_0/LDQ22	T
GND	GNDIO7	-			GNDIO7	-		
N9	PL19B	7	PCLKC7_0/LDQ16	C	PL25B	7	PCLKC7_0/LDQ22	C
M4	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	PL27A	6	PCLKT6_0/LDQ31	T (LVDS)*
M5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	PL27B	6	PCLKC6_0/LDQ31	C (LVDS)*
N7	PL22A	6	VREF2_6/LDQ25	T	PL28A	6	VREF2_6/LDQ31	T
P9	PL22B	6	VREF1_6/LDQ25	C	PL28B	6	VREF1_6/LDQ31	C
N3	PL23A	6	LDQ25	T (LVDS)*	PL29A	6	LDQ31	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
N4	PL23B	6	LDQ25	C (LVDS)*	PL29B	6	LDQ31	C (LVDS)*
N5	PL24A	6	LDQ25	T	PL30A	6	LDQ31	T
P7	PL24B	6	LDQ25	C	PL30B	6	LDQ31	C
T1	NC	-			PL31A	6	LDQS31	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
T2	NC	-			PL31B	6	LDQ31	C (LVDS)*
P8	NC	-			PL32A	6	LDQ31	T
P6	NC	-			PL32B	6	LDQ31	C
VCCIO	VCCIO6	6			VCCIO6	6		
P5	NC	-			PL33A	6	LDQ31	T (LVDS)*
P4	NC	-			PL33B	6	LDQ31	C (LVDS)*

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT45B	1		C	PT45B	1		C
A15	PT45A	1		T	PT45A	1		T
A13	PT44B	1		C	PT44B	1		C
B13	PT44A	1		T	PT44A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT43B	1		C	PT43B	1		C
H15	PT43A	1		T	PT43A	1		T
D13	PT42B	1		C	PT42B	1		C
C14	PT42A	1		T	PT42A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT41B	1		C	PT41B	1		C
E14	PT41A	1		T	PT41A	1		T
A12	PT40B	1		C	PT40B	1		C
B12	PT40A	1		T	PT40A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT39B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C
D14	PT39A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT37B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT37A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T
A11	PT36B	0		C	PT36B	0		C
B11	PT36A	0		T	PT36A	0		T
C13	PT35B	0		C	PT35B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT35A	0		T	PT35A	0		T
D12	PT34B	0		C	PT34B	0		C
F13	PT34A	0		T	PT34A	0		T
A10	PT33B	0		C	PT33B	0		C
B10	PT33A	0		T	PT33A	0		T
C12	PT32B	0		C	PT32B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT32A	0		T	PT32A	0		T
G13	PT31B	0		C	PT31B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT31A	0		T	PT31A	0		T
A9	PT30B	0		C	PT30B	0		C
B9	PT30A	0		T	PT30A	0		T
E12	PT29B	0		C	PT29B	0		C
G12	PT29A	0		T	PT29A	0		T
A8	PT28B	0		C	PT28B	0		C
B8	PT28A	0		T	PT28A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT27B	0		C	PT27B	0		C
C9	PT27A	0		T	PT27A	0		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U24	PR63B	3	RLM0_GPLLC_IN_A**/RDQ67	C (LVDS)*	PR76B	3	RLM0_GPLLC_IN_A**/RDQ80	C (LVDS)*
U25	PR63A	3	RLM0_GPLLT_IN_A**/RDQ67	T (LVDS)*	PR76A	3	RLM0_GPLLT_IN_A**/RDQ80	T (LVDS)*
R20	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
P18	VCCPLL	3			VCCPLL	-		
T19	PR61B	3	RLM0_GDLLC_FB_A/RDQ58	C	PR74B	3	RLM0_GDLLC_FB_A/RDQ71	C
U20	PR61A	3	RLM0_GDLLT_FB_A/RDQ58	T	PR74A	3	RLM0_GDLLT_FB_A/RDQ71	T
GND	GNDIO3	-			GNDIO3	-		
T25	PR60B	3	RLM0_GDLLC_IN_A**/RDQ58	C (LVDS)*	PR73B	3	RLM0_GDLLC_IN_A**/RDQ71	C (LVDS)*
T26	PR60A	3	RLM0_GDLLT_IN_A**/RDQ58	T (LVDS)*	PR73A	3	RLM0_GDLLT_IN_A**/RDQ71	T (LVDS)*
T20	PR59B	3	RDQ58	C	PR72B	3	RDQ71	C
T22	PR59A	3	RDQ58	T	PR72A	3	RDQ71	T
VCCIO	VCCIO3	3			VCCIO3	3		
R26	PR58B	3	RDQ58	C (LVDS)*	PR71B	3	RDQ71	C (LVDS)*
R25	PR58A	3	RDQS58	T (LVDS)*	PR71A	3	RDQS71	T (LVDS)*
R22	PR57B	3	RDQ58	C	PR70B	3	RDQ71	C
GND	GNDIO3	-			GNDIO3	-		
T21	PR57A	3	RDQ58	T	PR70A	3	RDQ71	T
P26	PR56B	3	RDQ58	C (LVDS)*	PR69B	3	RDQ71	C (LVDS)*
P25	PR56A	3	RDQ58	T (LVDS)*	PR69A	3	RDQ71	T (LVDS)*
R24	PR55B	3	RDQ58	C	PR68B	3	RDQ71	C
VCCIO	VCCIO3	3			VCCIO3	3		
R23	PR55A	3	RDQ58	T	PR68A	3	RDQ71	T
P20	PR54B	3	RDQ58	C (LVDS)*	PR67B	3	RDQ71	C (LVDS)*
R19	PR54A	3	RDQ58	T (LVDS)*	PR67A	3	RDQ71	T (LVDS)*
P21	PR53B	3	RDQ50	C	PR66B	3	RDQ63	C
GND	GNDIO3	-			GNDIO3	-		
P19	PR53A	3	RDQ50	T	PR66A	3	RDQ63	T
P23	PR52B	3	RDQ50	C (LVDS)*	PR65B	3	RDQ63	C (LVDS)*
P22	PR52A	3	RDQ50	T (LVDS)*	PR65A	3	RDQ63	T (LVDS)*
N22	PR51B	3	RDQ50	C	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3			VCCIO3	3		
R21	PR51A	3	RDQ50	T	PR64A	3	RDQ63	T
N26	PR50B	3	RDQ50	C (LVDS)*	PR63B	3	RDQ63	C (LVDS)*
N25	PR50A	3	RDQS50	T (LVDS)*	PR63A	3	RDQS63	T (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
N19	PR49B	3	RDQ50	C	PR62B	3	RDQ63	C
N20	PR49A	3	RDQ50	T	PR62A	3	RDQ63	T
M26	PR48B	3	RDQ50	C (LVDS)*	PR61B	3	RDQ63	C (LVDS)*
M25	PR48A	3	RDQ50	T (LVDS)*	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
N18	PR47B	3	VREF2_3/RDQ50	C	PR60B	3	VREF2_3/RDQ63	C
N21	PR47A	3	VREF1_3/RDQ50	T	PR60A	3	VREF1_3/RDQ63	T
L26	PR46B	3	PCLKC3_0/RDQ50	C (LVDS)*	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
L25	PR46A	3	PCLKT3_0/RDQ50	T (LVDS)*	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
N24	PR44B	2	PCLKC2_0/RDQ41	C	PR57B	2	PCLKC2_0/RDQ54	C
M23	PR44A	2	PCLKT2_0/RDQ41	T	PR57A	2	PCLKT2_0/RDQ54	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AJ6	PB16A	5	BDQ15	T
AK6	PB16B	5	BDQ15	C
VCCIO	VCCIO5	5		
GND	GNDIO5	-		
AD10	PB29A	5	BDQ33	T
AF10	PB29B	5	BDQ33	C
AC11	PB30A	5	BDQ33	T
AD11	PB30B	5	BDQ33	C
AG9	PB31A	5	BDQ33	T
AH9	PB31B	5	BDQ33	C
VCCIO	VCCIO5	99		
AE11	PB32A	5	BDQ33	T
AG10	PB32B	5	BDQ33	C
GND	GNDIO5	-		
AJ9	PB33A	5	BDQS33	T
AK9	PB33B	5	BDQ33	C
AF11	PB34A	5	BDQ33	T
AH10	PB34B	5	BDQ33	C
AC12	PB35A	5	BDQ33	T
AE12	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5		
AD12	PB36A	5	BDQ33	T
AF12	PB36B	5	BDQ33	C
AJ10	PB37A	5	BDQ33	T
AK10	PB37B	5	BDQ33	C
GND	GNDIO5	-		
AG11	PB38A	5	BDQ42	T
AH11	PB38B	5	BDQ42	C
AE13	PB39A	5	BDQ42	T
AC13	PB39B	5	BDQ42	C
AF13	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5		
AD13	PB40B	5	BDQ42	C
AJ11	PB41A	5	BDQ42	T
AK11	PB41B	5	BDQ42	C
AD14	PB42A	5	BDQS42	T
GND	GNDIO5	-		
AC14	PB42B	5	BDQ42	C
AG12	PB43A	5	BDQ42	T
AE14	PB43B	5	BDQ42	C
AJ12	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5		
AK12	PB44B	5	BDQ42	C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
E27	NC	-		
E28	NC	-		
E29	NC	-		
E3	NC	-		
E30	NC	-		
E4	NC	-		
E5	NC	-		
E6	NC	-		
F25	NC	-		
F5	NC	-		
F6	NC	-		
G6	NC	-		
G7	NC	-		
K10	NC	-		
K9	NC	-		
N27	NC	-		
N4	NC	-		
R1	NC	-		
R2	NC	-		
V27	NC	-		
V4	NC	-		
P22	VCCPLL	-		
P8	VCCPLL	-		
T22	VCCPLL	-		
Y7	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K19	PR16A	2	RDQ15	T	PR19A	2		T
G24	PR15B	2	RDQ15	C (LVDS)*	PR18B	2		C*
G23	PR15A	2	RDQS15	T (LVDS)*	PR18A	2		T*
GNDIO	GNDIO2	-			GNDIO2	-		
J18	PR14B	2	RDQ15	C	PR14B	2		C
F22	PR14A	2	RDQ15	T	PR14A	2		T
-	-	-			VCCIO2	2		
F23	PR13B	2	RDQ15	C (LVDS)*	PR13B	2		C*
F24	PR13A	2	RDQ15	T (LVDS)*	PR13A	2		T*
VCCIO	VCCIO2	2			-	-		
H20	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C	PR12B	2	RUM0_SPLLC_FB_A	C
-	-	-			GNDIO2	-		
F21	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T	PR12A	2	RUM0_SPLLT_FB_A	T
G26	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A	C*
F26	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A	T*
-	-	-			VCCIO2	2		
E24	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
E23	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO4	4			VCCIO2	2		
H19	XRES	-			XRES	-		
C25	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
A24	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B25	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
B24	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
C22	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A21	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
A22	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
B21	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
C21	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
B20	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
C20	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A20	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
C24	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
B23	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
C23	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
A23	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
B19	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E19	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D19	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
C19	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
A15	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AC15	PB27B	5	BDQ24	C	PB42B	5	BDQ42	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AD15	PB38A	5	BDQ42	T	PB47A	5	BDQ51	T
AF15	PB38B	5	BDQ42	C	PB47B	5	BDQ51	C
AG10	PB39A	5	BDQ42	T	PB48A	5	BDQ51	T
AG9	PB39B	5	BDQ42	C	PB48B	5	BDQ51	C
AH14	PB40A	5	BDQ42	T	PB49A	5	BDQ51	T
AG12	PB40B	5	BDQ42	C	PB49B	5	BDQ51	C
VCCIO	VCCIO5	5			VCCIO5	5		
AG15	PB41A	5	BDQ42	T	PB50A	5	BDQ51	T
AG13	PB41B	5	BDQ42	C	PB50B	5	BDQ51	C
GNDIO	GNDIO5	-			GNDIO5	-		
AF16	PB42A	5	BDQS42	T	PB51A	5	BDQS51	T
AH15	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C
AC16	PB43A	5	VREF2_5/BDQ42	T	PB52A	5	VREF2_5/BDQ51	T
AE16	PB43B	5	VREF1_5/BDQ42	C	PB52B	5	VREF1_5/BDQ51	C
AG11	PB44A	5	PCLKT5_0/BDQ42	T	PB53A	5	PCLKT5_0/BDQ51	T
AF11	PB44B	5	PCLKC5_0/BDQ42	C	PB53B	5	PCLKC5_0/BDQ51	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AJ14	PB49A	4	PCLKT4_0/BDQ51	T	PB58A	4	PCLKT4_0/BDQ60	T
VCCIO	VCCIO4	4			VCCIO4	4		
AK14	PB49B	4	PCLKC4_0/BDQ51	C	PB58B	4	PCLKC4_0/BDQ60	C
AK15	PB50A	4	VREF2_4/BDQ51	T	PB59A	4	VREF2_4/BDQ60	T
AK16	PB50B	4	VREF1_4/BDQ51	C	PB59B	4	VREF1_4/BDQ60	C
AF18	PB51A	4	BDQS51	T	PB60A	4	BDQS60	T
GNDIO	GNDIO4	-			GNDIO4	-		
AD16	PB51B	4	BDQ51	C	PB60B	4	BDQ60	C
AJ15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T
AG16	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C
AE17	PB53A	4	BDQ51	T	PB62A	4	BDQ60	T
VCCIO	VCCIO4	4			VCCIO4	4		
AC17	PB53B	4	BDQ51	C	PB62B	4	BDQ60	C
AH16	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T
AK17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C
AG20	PB55A	4	BDQ51	T	PB64A	4	BDQ60	T
GNDIO	GNDIO4	-			GNDIO4	-		
AG21	PB55B	4	BDQ51	C	PB64B	4	BDQ60	C
AG18	PB56A	4	BDQ60	T	PB65A	4	BDQ69	T
AJ16	PB56B	4	BDQ60	C	PB65B	4	BDQ69	C
AF21	PB57A	4	BDQ60	T	PB66A	4	BDQ69	T
AG22	PB57B	4	BDQ60	C	PB66B	4	BDQ69	C
AD17	PB58A	4	BDQ60	T	PB67A	4	BDQ69	T
AF19	PB58B	4	BDQ60	C	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
AH17	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K13	VCCIO0	0			VCCIO0	0		
D17	VCCIO1	1			VCCIO1	1		
E22	VCCIO1	1			VCCIO1	1		
E25	VCCIO1	1			VCCIO1	1		
F19	VCCIO1	1			VCCIO1	1		
K18	VCCIO1	1			VCCIO1	1		
K19	VCCIO1	1			VCCIO1	1		
F28	VCCIO2	2			VCCIO2	2		
J25	VCCIO2	2			VCCIO2	2		
K28	VCCIO2	2			VCCIO2	2		
M21	VCCIO2	2			VCCIO2	2		
M24	VCCIO2	2			VCCIO2	2		
N21	VCCIO2	2			VCCIO2	2		
N28	VCCIO2	2			VCCIO2	2		
P21	VCCIO2	2			VCCIO2	2		
R25	VCCIO2	2			VCCIO2	2		
AA28	VCCIO3	3			VCCIO3	3		
AB25	VCCIO3	3			VCCIO3	3		
AE28	VCCIO3	3			VCCIO3	3		
T25	VCCIO3	3			VCCIO3	3		
U21	VCCIO3	3			VCCIO3	3		
V21	VCCIO3	3			VCCIO3	3		
V28	VCCIO3	3			VCCIO3	3		
W21	VCCIO3	3			VCCIO3	3		
W24	VCCIO3	3			VCCIO3	3		
AA18	VCCIO4	4			VCCIO4	4		
AA19	VCCIO4	4			VCCIO4	4		
AE19	VCCIO4	4			VCCIO4	4		
AF22	VCCIO4	4			VCCIO4	4		
AG17	VCCIO4	4			VCCIO4	4		
AG25	VCCIO4	4			VCCIO4	4		
AA12	VCCIO5	5			VCCIO5	5		
AA13	VCCIO5	5			VCCIO5	5		
AE12	VCCIO5	5			VCCIO5	5		
AF9	VCCIO5	5			VCCIO5	5		
AG14	VCCIO5	5			VCCIO5	5		
AG6	VCCIO5	5			VCCIO5	5		
AA3	VCCIO6	6			VCCIO6	6		
AB6	VCCIO6	6			VCCIO6	6		
AE3	VCCIO6	6			VCCIO6	6		
T6	VCCIO6	6			VCCIO6	6		
U10	VCCIO6	6			VCCIO6	6		
V10	VCCIO6	6			VCCIO6	6		
V3	VCCIO6	6			VCCIO6	6		
W10	VCCIO6	6			VCCIO6	6		
W7	VCCIO6	6			VCCIO6	6		
F3	VCCIO7	7			VCCIO7	7		
J6	VCCIO7	7			VCCIO7	7		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
VCCIO	VCCIO3	3		
T22	PR69A	3	RDQ72	T
T29	PR68B	3	RDQ72	C (LVDS)*
T28	PR68A	3	RDQ72	T (LVDS)*
R23	PR66B	3	RLM4_SPLLC_FB_A/RDQ63	C
GNDIO	GNDIO3	-		
-	-	-		
R22	PR66A	3	RLM4_SPLLT_FB_A/RDQ63	T
P30	PR65B	3	RLM4_SPLLC_IN_A/RDQ63	C (LVDS)*
R29	PR65A	3	RLM4_SPLLT_IN_A/RDQ63	T (LVDS)*
T27	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
T26	PR64A	3	RDQ63	T
GNDIO	GNDIO3	-		
N30	PR61B	3	RDQ63	C (LVDS)*
N29	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
R27	PR60B	3	VREF2_3/RDQ63	C
R28	PR60A	3	VREF1_3/RDQ63	T
P29	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
P28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
M30	PR57B	2	PCLKC2_0/RDQ54	C
M29	PR57A	2	PCLKT2_0/RDQ54	T
GNDIO	GNDIO2	-		
P23	PR56B	2	RDQ54	C (LVDS)*
P24	PR56A	2	RDQ54	T (LVDS)*
R26	PR55B	2	RDQ54	C
P27	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
P25	PR54B	2	RDQ54	C (LVDS)*
P26	PR54A	2	RDQS54	T (LVDS)*
K30	PR53B	2	RDQ54	C
GNDIO	GNDIO2	-		
K29	PR53A	2	RDQ54	T
N22	PR52B	2	RDQ54	C (LVDS)*
P22	PR52A	2	RDQ54	T (LVDS)*
J30	PR51B	2	RUM3_SPLLC_FB_A/RDQ54	C
VCCIO	VCCIO2	2		
J29	PR51A	2	RUM3_SPLLT_FB_A/RDQ54	T
N24	PR50B	2	RUM3_SPLLC_IN_A/RDQ54	C (LVDS)*
N23	PR50A	2	RUM3_SPLLT_IN_A/RDQ54	T (LVDS)*
N25	PR48B	2	RDQ45	C
N26	PR48A	2	RDQ45	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO1	-			GNDIO1	-		
F19	PT59B	1		C	PT68B	1		C
D18	PT59A	1		T	PT68A	1		T
L18	NC	-			PT67B	1		C
K19	NC	-			PT67A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A18	PT57B	1	VREF2_1	C	PT66B	1	VREF2_1	C
B18	PT57A	1	VREF1_1	T	PT66A	1	VREF1_1	T
G18	PT56B	1	PCLKC1_0	C	PT65B	1	PCLKC1_0	C
E18	PT56A	1	PCLKT1_0	T	PT65A	1	PCLKT1_0	T
F18	PT55B	0	PCLKC0_0	C	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	-		
G19	PT55A	0	PCLKT0_0	T	PT64A	0	PCLKT0_0	T
H18	PT54B	0	VREF2_0	C	PT63B	0	VREF2_0	C
K18	PT54A	0	VREF1_0	T	PT63A	0	VREF1_0	T
VCCIO	VCCIO0	0			VCCIO0	0		
J18	PT53B	0		C	PT60B	0		C
L17	PT53A	0		T	PT60A	0		T
G17	PT52B	0		C	PT59B	0		C
-	-	-			GNDIO0	-		
J17	PT52A	0		T	PT59A	0		T
H17	PT51B	0		C	PT58B	0		C
-	-	-			VCCIO0	0		
K17	PT51A	0		T	PT58A	0		T
B17	PT50B	0		C	PT57B	0		C
GNDIO	GNDIO0	-			-	-		
A17	PT50A	0		T	PT57A	0		T
D17	PT49B	0		C	PT56B	0		C
VCCIO	VCCIO0	0			-	-		
F17	PT49A	0		T	PT56A	0		T
B16	PT48B	0		C	PT55B	0		C
A16	PT48A	0		T	PT55A	0		T
-	-	-			GNDIO0	-		
-	-	-			VCCIO0	0		
E17	PT47B	0		C	PT52B	0		C
C17	PT47A	0		T	PT52A	0		T
K16	PT46B	0		C	PT51B	0		C
J15	PT46A	0		T	PT51A	0		T
GNDIO	GNDIO0	-			GNDIO0	-		
G16	PT45B	0		C	PT50B	0		C
H15	PT45A	0		T	PT50A	0		T
A15	PT44B	0		C	PT49B	0		C
B15	PT44A	0		T	PT49A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
L16	PT43B	0		C	PT48B	0		C
K15	PT43A	0		T	PT48A	0		T
F16	PT42B	0		C	PT47B	0		C
E16	PT42A	0		T	PT47A	0		T
E15	PT41B	0		C	PT46B	0		C

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	COM	100
LFE2M100E-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	COM	100
LFE2M100E-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	COM	100
LFE2M100E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	100
LFE2M100E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	100
LFE2M100E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	100

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484I	304	1.2V	-5	Lead-Free fpBGA	484	IND	20
LFE2M20E-6FN484I	304	1.2V	-6	Lead-Free fpBGA	484	IND	20
LFE2M20E-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	IND	20
LFE2M20E-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672I	410	1.2V	-5	Lead-Free fpBGA	672	IND	35
LFE2M35E-6FN672I	410	1.2V	-6	Lead-Free fpBGA	672	IND	35
LFE2M35E-5FN484I	303	1.2V	-5	Lead-Free fpBGA	484	IND	35
LFE2M35E-6FN484I	303	1.2V	-6	Lead-Free fpBGA	484	IND	35
LFE2M35E-5FN256I	140	1.2V	-5	Lead-Free fpBGA	256	IND	35
LFE2M35E-6FN256I	140	1.2V	-6	Lead-Free fpBGA	256	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900I	410	1.2V	-5	Lead-Free fpBGA	900	Ind	50
LFE2M50E-6FN900I	410	1.2V	-6	Lead-Free fpBGA	900	Ind	50
LFE2M50E-5FN672I	372	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2M50E-6FN672I	372	1.2V	-6	Lead-Free fpBGA	672	Ind	50
LFE2M50E-5FN484I	270	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2M50E-6FN484I	270	1.2V	-6	Lead-Free fpBGA	484	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152I	436	1.2V	-5	Lead-Free fpBGA	1152	Ind	70
LFE2M70E-6FN1152I	436	1.2V	-6	Lead-Free fpBGA	1152	Ind	70
LFE2M70E-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2M70E-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	70

Date	Version	Section	Change Summary
August 2006 (cont.)	01.1 (cont.)	Pinout Information (cont.)	Added Information on: Available Device Resources per Packaged Device table.
		Ordering Information	Updated ordering part number table to include ECP2-12.
			Updated topside mark drawing.
September 2006	02.0	Multiple	Added information regarding LatticeECP2M support throughout.
September 2006	02.1	DC and Switching Characteristics	Added Receiver Total Jitter Tolerance Specification table.
			Removed power-up requirements for proper configuration footnote in Recommended Operating Conditions table.
December 2006	02.2	Introduction	LatticeECP2M Selection Guide table has been updated.
		Architecture	Figure 2-16. Per Region Secondary Clock Selection has been updated.
			Figure 2-39. Simplified Channel Block Diagram for SERDES and PCS has been updated.
		DC and Switching	Footnotes have been added to Recommended Operating Conditions.
			DC Electrical Characteristics table has been updated.
			Supply Current (Standby) tables have been updated.
			Initialization Supply Current table have been updated.
			Updated timing numbers to include LFE2-12E (rev A 0.08).
		Pinout Information	Updated to include the entire ECP2 device information as well as 256-fpBGA and 484-fpBGA pin information for the ECP2M35E.
		Ordering Information	Updated to include the entire ECP2 and ECP2M device ordering information.
February 2007	02.3	Architecture	Updated EBR Asynchronous Reset section.
March 2007	02.4	DC and Switching Characteristics	Power-sequencing footnotes have been added to the Recommended Operating Conditions. DDR2 performance has been updated to 266MHz.
March 2007	02.5	Introduction	Added “Security Series” to the LatticeECP2 and LatticeECP2M families.
		Architecture	Enhanced Configuration Option section updated.
		DC and Switching	Recommended Operating Conditions table - footnote 4 updated.
		Ordering Information	“Security Series” ordering part numbers added.
April 2007	02.6	Introduction	LatticeECP2M family table has been updated for user I/O counts.
		Ordering Information	LatticeECP2M family ordering part number section has been updated to add 1152-fpBGA package for the ECP2M70 and ECP2M100.
July 2007	02.7	Architecture	Updated text in Ripple Mode section.
		DC and Switching	ECP2/M Supply Current information has been updated. Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.10). SERDES timing information has been updated. PCI Express timing information has been updated.
		Pinout Information	Added LatticeECP2M20 pinout information.
August 2007	02.8	Introduction	1156-fpBGA package option has been removed from the LatticeECP2M family.
		Architecture	Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration table has been updated.
		DC and Switching	Supply Current (Standby) table has been updated.
			DSP Function timing has been updated.